



III-V Lab offers a unique capability in Europe for epitaxial wafers based on the four III-V materials families (GaN, InP, GaAs and GaSb).

► From R&D to niche market production

- III-V Lab can support your projects thanks to a pool of 7 MBE, MOVPE, GSMBE reactors at the state of the art and located in Paris-Saclay (France).

► A dual offer

- Standard epitaxial structures,
- Advanced epitaxy development studies, on wafers ranging from 2 inches to 200 mm.



► Standard epitaxial structures

- at reduced non-recurring costs,
 - and in a short cycle-time,
- thanks to more than 20 years of experience in high-end and advanced epitaxial III-V materials growth :

5	10.811	6	12.011	7	14.007	8	15.999
B	C	N	O				
BORE	CARBONE	AZOTE	OXYGÈNE				
13	26.982	14	28.086	15	30.974	16	32.065
Al	Si	P	S				
ALUMINIUM	SILICIUM	PHOSPHORE	SOUFRE				
30	65.39	31	69.723	32	72.64	33	74.922
Zn	Ga	Ge	As	Se			
ZINC	GALLIUM	GERMANIUM	ARSENIC	SELENIUM			
48	112.41	49	114.82	50	118.71	51	121.76
Cd	In	Sn	Sb	Te			
CADMIUM	INDIUM	ÉTAIN	ANTIMOINE	TELLURE			

STANDARD	Epitaxial structures or building blocks	Materials		Max. wafer diameter
		Substrate	Typical epitaxy stacks	
Photronics products	QCL / QCD(1)	InP	AlInAs/GaInAs	100mm
	QCL	GaAs	AlAs/AlGaAs	200mm
		GaSb	AlSb/InAs	100mm
		GaAs	Stacks for wavelength from 780nm to 1.06µm	100mm
	MQW (2) for laser diodes	InP	Stacks for wavelength from 1.3 to 1.6µm	100mm
		GaSb	AlGaAsSb/GaInAsSb for wavelength from 2 to 2.5µm	100mm
	SOA (3)	InP	Stacks for C and O bands	3 inches
	APD-UTC (4) detectors	InP	Quaternary alloys on InP	3 inches
	Infrared Detectors	GaAs, GaSb, InP	Stacks for SWIR (7), MWIR (8) & LWIR (9)	100mm
	SIBH regrowth	InP	Semi-insulating InP (Fe, Ru)	3 inches
Regrowth on grating	InP, GaAs	Buried gratings for DFB laser diodes	100mm	
Butt Joint Integration	InP	Passive structures	3 inches	
Zn diffusion	InP	-	100mm	
Electronics products	InP HBT Transistors (5)	InP	InGaAs/InP	100mm
	GaN HEMT Transistors (6)	SiC	InAlGaN, AlGaN/GaN	100mm

(1): QCL: Quantum Cascade Laser / QCD: Quantum Cascade Detector

(2) : MQW: Multi Quantum Wells

(3) : SOA: Semiconductor Optical Amplifier

(4) : APD: Avalanche Photodiode / UTC: Unitravelling Carrier

(5): HBT: Heterojunction Bipolar Transistor

(6): HEMT: High Electron Mobility Transistor

(7): SWIR: Short Wave Infra-Red (1.3-1.7µm)

(8): MWIR: Medium Wave Infra-Red (3-5µm)

(9): LWIR: Long Wave Infra-Red (8-12µm)

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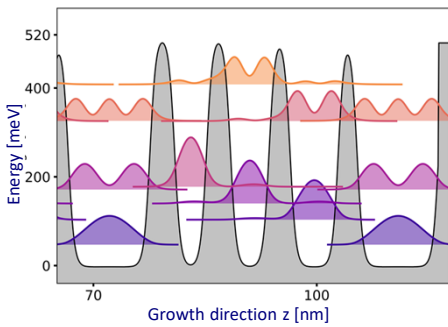
III-V Lab is certified ISO9001-2015



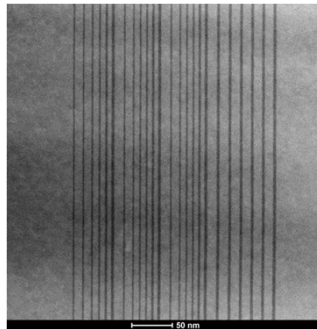
► Advanced developments

III-V Lab can assist your project in order to match with your specifications and propose :

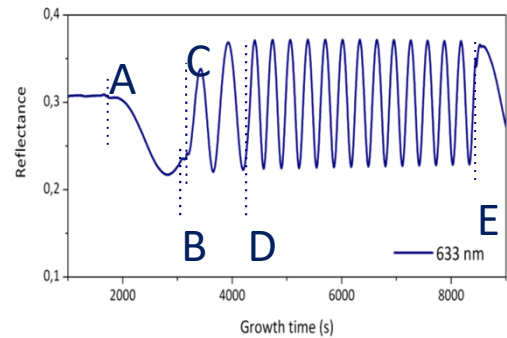
- Specification definition based on long track record experience,
- Epitaxial structure optimization by design in simulation,
- Fast wafer manufacturing and validation with in situ and post-manufacturing controls,
- Process stabilization through statistical data-meaning and DOEs.



Stack simulation



Stack manufacturing



Stack controls

- Advanced epitaxial structures can be developed on demand by adjusting process parameters, alloys and doping elements, according to the available options given below :

Technology	Services			III-V alloys families				Doping elements	Max wafer diameter
	Epi. wafer	Regrowth	Zn diffusion	Nitrides (N)	Phosphides (P)	Arsenides (As)	Antimonides (Sb)		
MBE	X					X	X	Si, Te, Be	200mm
MOVPE		X			X	X		Fe, Si, Ru	100mm
	X	X	X	X	X	X		Mg, Si	150mm
GSMBE	X	X			X	X		Zn, C, S, Si, Te	200mm
	X	X			X	X		Si, Be	100mm

Capabilities